

A Sub-nW 100 ppm/°C Self-Biased Voltage Reference Circuit for IOT Applications.

TARANVEER KAUR¹ and Arvind kumar¹

¹Panjab University

January 27, 2023

Abstract

A sub-nW, self-biased voltage reference circuit is developed to provide bias signals for use in Internet-of-Things (IOT) applications, taking use of the sub-threshold region operation MOSFETs. Circuit is evaluated by simulation with 180nm SCL's CMOS device parameters and 1.8 V voltage supply and from temperature -40°C to 125°C. Simulation shows that a temperature sensitivity of designed voltage reference is less than 100 ppm/°C. The size of the proposed design without IO pads is 30 μm $\times$ 30 μm and consumes power less than 50 nW.

Hosted file

elecronis_letter_25_1_23.docx available at <https://authorea.com/users/580076/articles/621303-a-sub-nw-100-ppm-c-self-biased-voltage-reference-circuit-for-iot-applications>

A Sub-nW 100 ppm/°C Self-Biased Voltage Reference Circuit for IOT Applications

A sub-nW, self-biased voltage reference circuit is developed to provide bias signals for use in Internet-of-Things (IOT) applications, taking use of the sub-threshold region operation MOSFETs. Circuit is evaluated by simulation with 180nm SCL's CMOS device parameters and 1.8 V voltage supply and from temperature -40°C to 125°C. Simulation shows that a temperature sensitivity of designed voltage reference is less than 100 ppm/°C. The size of the proposed design without IO pads is 30 $\mu\text{m} \times 30 \mu\text{m}$ and consumes power less than 50 nW.

Introduction: References, voltage or current are essential parts of various systems. They produce constant output voltages for required application-based temperature range and act as process, voltage, and temperature insensitive references. Critical for developing energy-constrained systems, including the biomedical devices and self-powered wearable electronic gadgets. To reduce idle power consumption and extend operational life when working with restricted source energy, these systems attract the mixed-signal ICs to a nano-watt or pico-watt voltage reference [1][2]. Additionally, the voltage reference should be able to function at low supply voltages [3][4] like 1.2V, 0.5 V or even lower because the supply voltages of ICs are repeatedly decreasing due to process scaling. The demand for low-power analog mixed signal (AMS) circuits has rapidly increased in the present period due to the limited size and capacity of battery devices. Voltage reference circuits are essential for providing a precise and stable DC bias in AMS circuits like ADC/DAC comparators, operational amplifiers, PLLs, etc. in any kind of environment. Due to scaling of voltage and power, there has been a significant challenge in the design of voltage reference circuits. Voltage references are an important block of these AMS circuits and overall performance heavily depends on the performance of the voltage reference circuits. Many analog circuits find the use of temperature independent reference voltages or currents indispensable. Since most process parameters are also affected by temperature, a voltage reference that is temperature-independent is also less process-independent. The two main forms of VRs are BJT based band-gap voltage references and using subthreshold property of CMOS based voltage references. The conventional structure of bandgap-based voltage reference (BGR) [5] provides a constant voltage depending on the current- V_{BE} properties of the diode [6]. The CMOS transistors are used by CVR to create a stable reference voltage. Because resistors are required in traditional BGR designs, BGR rarely achieves low power consumption, which has an impact on the operation of ultra-low-power applications like Internet of Things devices. The low temperature sensitivity reference voltages could not be produced by the conventional band-gap voltage reference technique, which mostly consists of lateral PNP transistors [7], at a supply level below 1V without the use of additional circuits. Low power reference voltages and currents are also frequently produced by MOSFETs working in the sub-threshold region. Basic concept of the temperature independent voltage reference generation is adding with proper weighting of two quantities having opposite temperature dependencies, the output has zero temperature sensitivity [8]. If we add negative TC voltage VCTAT and positive TC voltage VPTAT with weight α and β such that.

$$\alpha \frac{\partial V_{CTAT}}{\partial T} + \beta \frac{\partial V_{PTAT}}{\partial T} = 0 \quad (1)$$

In this work, designed a low power voltage reference circuit for across a temperature range from -40°C to 125°C using subthreshold property of MOS.

Operating Principle: In sub-threshold region, all currents must be created by diffusion because there are no moderately or strongly inverted portions of the channel and the electric field has no horizontal component. [9]. Assuming long channel length, if $V_{DS} > 4\Phi_T$, the expression for drain current then simplifies to

$$I_{DS} = I_S \exp\left(\frac{V_{GS} - V_{TH}}{n\Phi_T}\right) \quad (2)$$

$$I_S = 2n\mu C_{ox} \frac{W}{L} \Phi_T^2 \quad (3)$$

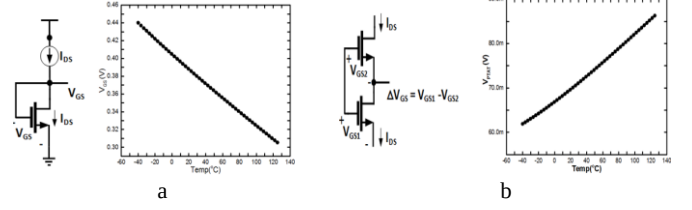


Fig. 1 (a) V_{GS} versus Temperature; (b) V_{PTAT} versus Temperature

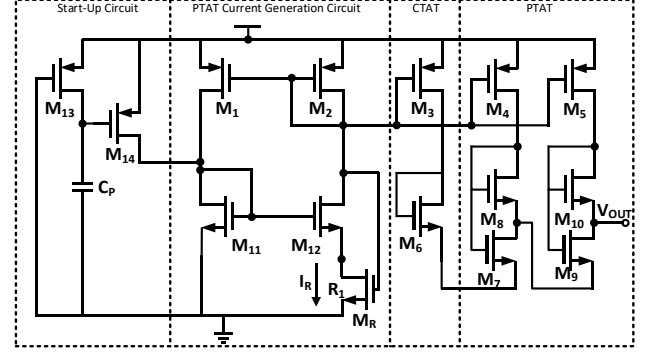


Fig. 2 circuit diagram of proposed work

The configuration of Fig.1, NMOS transistor simulated using a 180nm standard CMOS process parameters at 1V power supply. Transistor was biased with 100nA current, generates CTAT and PTAT voltages, as

$$V_{GS} = n\Phi_T \ln\left(\frac{I_D}{I_S}\right) + V_{TH} \quad (4)$$

$$V_{TH}(T) = V_{TH}(T_0) + k(T - T_0) \quad (5)$$

$$\begin{aligned} \Delta V_{GS} = V_{GS1} - V_{GS2} &= V_{DS1} \\ &= n\Phi_T \ln \left[\left(\frac{W}{L} \right)_2 \frac{I_{DS1}}{\left(\frac{W}{L} \right)_1 I_{DS2}} \right] + (V_{TH1} - V_{TH2}) \end{aligned} \quad (6)$$

Where n is the sub-threshold slope factor which is in modern CMOS processes ranges between 1.3 to 1.5, V_{DS} is drain-source voltage, V_{TH} is threshold voltage, V_{GS} is gate-source voltage, Φ_T is thermal potential, T represent room temperature in Kelvin [300K], k (Boltzmann constant), q is charge of electron, for a given small drain current $V_{GS} \approx V_{TH}$. The size ratio of transistor $(W/L)_2/(W/L)_1$ should be higher than 20 [10] to ensure that M1 is working in saturation region. It should be noted that M1 and M2 must both be operating in weak inversion.

Circuit description of proposed work: The low power voltage reference circuit is shown in Fig.2, it has four main parts. M13, M14, C_p forms Start-up circuit to avoid zero bias condition and does not affect the final output voltage. MR is working in deep triode region and works as resistor R_1 , and its value can be chosen as

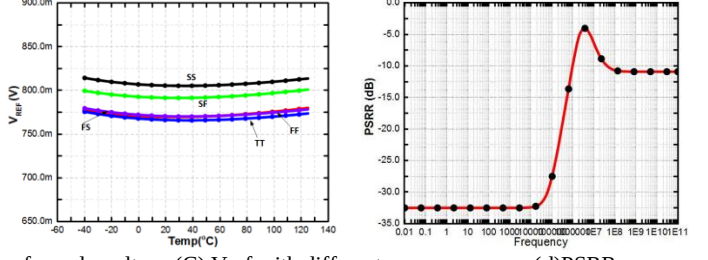
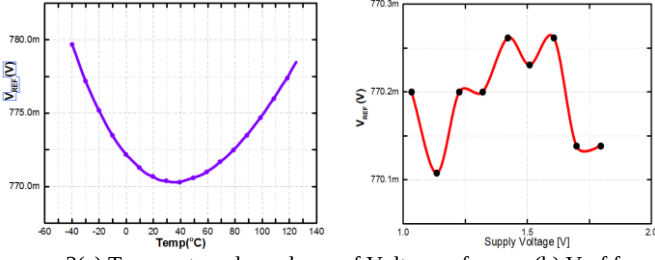
$$R_1 = \frac{L}{\mu C_{ox} W (V_{GS} - V_{TH})} \quad (7)$$

M6 to M12 transistors operated in subthreshold region. M1, M2, M11, M12, R_1 forms PTAT current generation circuit. Considering that $(W/L)_1 = (W/L)_2 = (W/L)_3$, the bias current (from Fig.2) is given by:

$$I_{BIAS} = \frac{(V_{GS1} - V_{GS2})}{R_1} \quad (8)$$

For this proposed circuit, we choose I_{BIAS} equal to $\sim 357\text{nA}$ and R_1 is equivalent to around 100 K Ω . M3 mirrors the PTAT current into diode connected M6 and generates CTAT voltage. M7, M8, M9, M10 forms PTAT generation circuits and M4, M5 mirrors the PTAT current into PTAT. VREF is a sum of CTAT voltage and a properly scaled PTAT voltage. The output voltage of the circuit is given by:

$$V_{REF} = V_{D14} + V_{DS7} + V_{DS9} \quad (9)$$



3(a) Temperature dependence of Voltage reference (b) Vref function of supply voltage (c) Vref with different process corners (d) PSRR
The current through M4, M5 and M6 are respectively: \$(S_4/S_2) \cdot I_{BIAS}\$, \$(S_5/S_2) \cdot I_{BIAS}\$ and \$(S_6/S_2) \cdot I_{BIAS}\$, S represents \$(\frac{W}{L})\$. If neglect the body effect then,

$$V_{REF} = V_{D14} + (V_{GS7} - V_{GS8}) + (V_{GS9} - V_{GS10}) \quad (10)$$

$$V_{REF} = V_{D14} + n\phi_T \ln\left[\frac{S_8}{S_7} \frac{I_{DS7}}{I_{DS8}}\right] + n\phi_T \ln\left[\frac{S_{10}}{S_9} \frac{I_{DS9}}{I_{DS10}}\right] \quad (11)$$

$$I_{DS9} = I_{DS10} + \frac{S_6}{S_2} I_{BIAS} \quad (12)$$

$$V_{REF} \quad (13)$$

$$= V_{D14} + n\phi_T \ln\left[\frac{(S_4 + S_5 + S_6)(S_5 + S_6)S_8S_{10}}{S_4S_5S_7S_9}\right] + n\phi_T \ln\left[\frac{S_8}{S_7} \frac{S_{10}}{S_9} \left(\frac{S_4 + S_5 + S_6}{S_2}\right) \frac{S_2}{S_4} \left(\frac{S_5 + S_6}{S_2}\right) \frac{S_2}{S_5}\right]$$

From (11) With the right device dimensions, slope of CTAT and PTAT can be matched and \$(\delta V_{REF} / \delta T) = 0\$ can generate.

Design and Verification Result: Schematic and layout of the circuit done using Cadence Virtuoso software. Schematic of the sub-threshold based low power voltage reference circuit is shown in fig.2, and layout of the voltage reference has been done using 4-metal 180nm SCL's CMOS process and shown in fig.4. The die size of device is \$30 \mu m \times 30 \mu m\$. To verify the circuit behaviour, and to confirm the operation of sub-threshold MOS based voltage reference circuit, all simulations were performed using Synopsys H-spice Simulator using a set of standard 180nm CMOS process parameters. At typical process corner, room temperature and 1.8V voltage supply and circuit generates 770mV. Figure.3(a) shows a temperature stability results. Simulation performed from -40°C to 125°C temperature, and it achieves a temperature sensitivity of 100 ppm/°C in complete temperature range. To verify supply voltage stability in simulation, supply voltage varies from 1V to 1.8V and results is shown in figure.3(b). Reference voltage is varying approximately only 150μV. Process corner simulations performed to investigate the reference voltage dependence on the variation in the process. The Simulated Result of output voltage vs. temperature with process corner are depicted in figure.3(c). Generally, IoT applications are battery operated systems, and supply voltages are less noisy. To analyse power supply noise effect on the voltage reference circuit to power supply noise the PSR simulation performed. Figure.3(d) shows a different value of PSRR at different frequencies and achieved PSR of -33db@100 HZ.

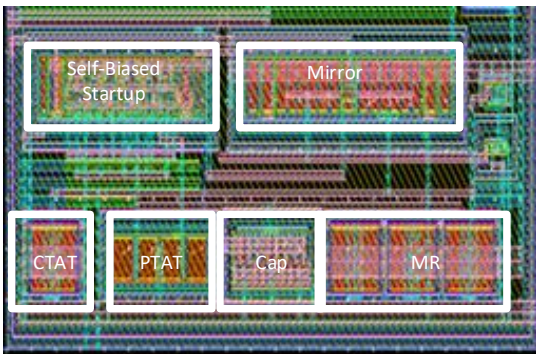


Fig. 4 Layout diagram of proposed work

Conclusion: A CMOS voltage reference below threshold (CVR) It has been demonstrated to use a low power consumption in the 0.18 μm SCL CMOS process. The suggested circuit operates with low voltage and little power by utilising MOS transistors with subthreshold working regions. Using subthreshold region functioning, a temperature-independent voltage reference circuit for nano-power devices is created. The suggested circuit generates 770 mV at room temperature and achieves temperature sensitivity of 100 ppm/°C over a temperature range of -40 °C to 125 °C utilising a set of 0.18 m SCL's standard CMOS process settings and 1.8 v voltage supply. The device uses less than 50 nW of electricity and takes up a chip size of 30 μm by 30 μm.

References

- [1] H. Zhang et al., "A nano-watt MOS-only voltage reference with high-slope PTAT voltage generators", IEEE Trans. Circuits Syst. II Exp. Briefs, vol. 65, no. 1, pp. 1-5, Jan. 2018.
- [2] I. Lee, D. Sylvester and D. Blaauw, "A subthreshold voltage reference with scalable output voltage for low-power IoT systems", IEEE J. Solid-State Circuits, vol. 52, no. 5, pp. 1443-1449, May 2017.
- [3] D. Albano, F. Crupi, F. Cucchi and G. Iannaccone, "A sub-kT/q voltage reference operating at 150 mV", IEEE Trans. Very Large Scale Integr. (VLSI) Syst., vol. 23, no. 8, pp. 1547-1551, Aug. 2015.
- [4] Z. Zhu, J. Hu and Y. Wang, "A 0.45 V Nano-Watt 0.033%-line sensitivity MOSFET-only sub-threshold voltage reference with no amplifiers", IEEE Trans. Circuits Syst. I Reg. Papers, vol. 63, no. 9, pp. 1370-1310, Sep. 2016.
- [5] Xie, L., Liu, J., Wang, Y. et al. A low power CMOS voltage reference generator with temperature and process compensation. Analog Integr Circ Sig Process 81, 313–324 (2014).
- [6] Y. Lei, C. Zhan, C. Huang and L. Wang, "A Chip-Area-Efficient Subthreshold CMOS Voltage Reference with High PSRR Based on Compensated ΔVGS of NMOS Transistors," 2018 IEEE Asia Pacific Conference on Circuits and Systems (APCCAS), Chengdu, China, 2018, pp. 497-500.
- [7] A. R. Mohamed, M. Chen and G. Wang, "Untrimmed CMOS Nano-Ampere Current Reference with Curvature-Compensation Scheme," 2019 IEEE International Symposium on Circuits and Systems (ISCAS), Sapporo, Japan, 2019, pp. 1-4.
- [8] R. J. Widlar, "New developments in IC voltage regulators", IEEE J. Solid-State Circ, vol. 6, no. 1, pp. 2-7, Jan. 1971
- [9] Yannis Tsvividis, Colin McAndrew "Operation and Modeling of the MOS Transistor", The Oxford Series in Electrical and Computer Engineering Series.
- [10] Shailesh Singh Chouhan and Kari Halonen, "A 0.67-μW 177-ppm/°C All-MOS Current Reference Circuit in a 0.18-μm CMOS Technology", IEEE Transactions on Circuits and Systems-II: Express Briefs, Vol. 63, No. 8, August